## F2914

High Reliability SP4T RF Switch, 50 MHz to 8000 MHz

## Description

The F2914 is a high reliability, low insertion loss, $50 \Omega$ SP4T absorptive RF switch designed for a multitude of RF applications including wireless communications. This device covers a broad frequency range from 50 MHz to 8000 MHz . In addition to providing low insertion loss, the F2914 also delivers excellent linearity and isolation performance while providing a $50 \Omega$ termination to the unused RF input ports. The F2914 also includes a patent pending constant impedance ( $\mathrm{K}_{z}$ ) feature. $\mathrm{K}_{z}$ improves system hot switching ruggedness, minimizes LO pulling in VCOs, and reduces phase and amplitude variations in distribution networks. It is also ideal for dynamic switching / selection between two or more amplifiers while avoiding damage to upstream /downstream sensitive devices such as PAs and ADCs.

The F2914 uses a single positive supply voltage supporting three logic control pins using either 3.3 V or 1.8 V control logic. Connecting a negative voltage to pin 20 disables the internal negative voltage generator and becomes the negative supply.

Functional Block Diagram


## Features

- Four symmetric, absorptive RF ports
- High Isolation: 50 dB at 4000 MHz
- Low Insertion Loss: 1.1 dB at 4000 MHz
- High Linearity

IIP2 of 114 dBm at 2000 MHz

- IIP3 of 60 dBm at 4000 MHz
- High Operating Power Handling:
- 33 dBm CW on selected RF port
- 27 dBm on terminated ports
- Single 2.7 V to 5.5 V supply voltage
- External Negative Supply Option
- 3.3 V and 1.8 V compatible control logic
- Operating temperature $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
- $4 \times 4 \mathrm{~mm} 24$-pin QFN package
- Pin compatible with competitors


## Competitive Advantage

The F2914 provides constant impedance in all RF ports during transitions improving a system's hotswitching ruggedness. The device also supports high power handling, and high isolation; particularly important for DPD receiver use.

- Constant impedance $\mathrm{K}|\mathrm{Z}|$ during switching transition
- RFX to RFC Isolation $=50 \mathrm{~dB}$ at 4 GHz
- Insertion Loss $=1.1 \mathrm{~dB}$ at 4 GHz
- IIP3: +60 dBm at 4GHz
- Extended temperature: $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$


## Applications

- Base Station 2G, 3G, 4G
- Portable Wireless
- Repeaters and E911 systems
- Digital Pre-Distortion
- Point to Point Infrastructure
- Public Safety Infrastructure
- Military Systems, JTRS radios
- Cable Infrastructure
- Test / ATE Equipment


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## 1. Pin Information

### 1.1 Pin Diagram



### 1.2 Pin Descriptions

| Pin | Name | Function |
| :---: | :---: | :---: |
| $\begin{gathered} 1,3,4,6,7,9,10,12,13 \\ 15,21,23,24 \end{gathered}$ | GND | Ground these pins as close to the device as possible. |
| 2 | GND | This pin is internally connected to the exposed paddle. This pin can be left open or grounded. Note: The EVKIT layout has a floating RF trace connected to this pin to make the board compatible with the F2915. |
| 5 | RF4 | RF4 Port. Matched to 50 ohms. If this pin is not $0 V$ DC, then an external coupling capacitor must be used. |
| 8 | RF3 | RF3 Port. Matched to 50 ohms. If this pin is not OV DC, then an external coupling capacitor must be used. |
| 11 | RF2 | RF2 Port. Matched to 50 ohms. If this pin is not $0 V$ DC, then an external coupling capacitor must be used. |
| 14 | RF1 | RF1 Port. Matched to 50 ohms. If this pin is not $0 V$ DC, then an external coupling capacitor must be used. |
| 16 | VDD | Power Supply. Bypass to GND with capacitors shown in the Typical Application Circuit as close as possible to pin. |
| 17 | V1 | Control pin to set switch state. See Table 1 or Table 2. |
| 18 | V2 | Control pin to set switch state. See Table 1 or Table 2. |
| 19 | V3 | Control pin to set switch state. See Table 1 or Table 2. |
| 20 | $\mathrm{VSS}_{\text {EXt }}$ | External VSS negative voltage control. Connect to ground to enable on chip negative voltage generator. To bypass and disable on chip generator connect this pin to an external VSS. |
| 22 | RFC | RF Common Port. Matched to 50 ohms when one of the 4 RF ports is selected. If this pin is not OV DC, then an external coupling capacitor must be used. |
| 25 | -EP | Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple ground vias are also required to achieve the specified RF performance. |

## 2. Absolute Maximum Ratings

Table 1. Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ to GND | $V_{\text {DD }}$ | -0.3 | +6.0 | V |
| V1, V2, V3 to GND | $\mathrm{V}_{\text {CNTL }}$ | -0.3 | $\begin{gathered} \text { Minimum } \\ \left(3.6, \mathrm{~V}_{\mathrm{DD}}+0.3\right) \end{gathered}$ | V |
| RF1, RF2, RF3, RF4, RFC to GND | $\mathrm{V}_{\text {RF }}$ | -0.3 | +0.3 | V |
| $\mathrm{VSS}_{\text {EXT }}$ to GND | $V_{\text {EXT }}$ | -4.0 | +0.3 | V |
| Input Power for any one selected RF through port. ( $\mathrm{V}_{\mathrm{DD}}$ applied @ 2 GHz and $\mathrm{T}_{\mathrm{C}}=+85^{\circ} \mathrm{C}$ ) | $\mathrm{P}_{\text {maxthru }}$ |  | 37 | dBm |
| Input Power for any one selected RF terminated port .( $\mathrm{V}_{\mathrm{DD}}$ applied @ 2 GHz and $\mathrm{T}_{\mathrm{C}}=+85^{\circ} \mathrm{C}$ ) | $\mathrm{P}_{\text {maxterm }}$ |  | 30 | dBm |
| Input Power for RFC when in the all off state. ( $\mathrm{V}_{\mathrm{DD}}$ applied @ 2 GHz and $\mathrm{T}_{\mathrm{C}}=+85^{\circ} \mathrm{C}$ ) | $\mathrm{P}_{\text {maxcom }}$ |  | 33 | dBm |
| Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{C}}=95{ }^{\circ} \mathrm{C}$ Max) |  |  | 3 | W |
| Maximum Junction Temperature | $\mathrm{T}_{\text {Jmax }}$ |  | +140 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {ST }}$ | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (soldering, 10s) | $\mathrm{T}_{\text {LEAD }}$ |  | +260 | ${ }^{\circ} \mathrm{C}$ |
| ESD Voltage- HBM (Per JESD22-A114) | $V_{\text {ESDHBM }}$ |  | Class 1C (1000 V) |  |
| ESD Voltage - CDM (Per JESD22-C101) | $V_{\text {ESDCDM }}$ |  | Class III (1000 V) |  |

$\mathrm{T}_{\mathrm{c}}=$ Temperature of the exposed paddle
Stresses above those listed above may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## 3. Package Thermal and Moisture Characteristics

Table 2. Package Thermal and Moisture Characteristics

| Characteristic | Value |
| :---: | :---: |
| $\theta_{\mathrm{JA}}$ (Junction - Ambient) | $41{ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\mathrm{JC}}$ (Junction - Case) [The Case is defined as the exposed paddle] | $6.4^{\circ} \mathrm{C} / \mathrm{W}$ |
| Moisture Sensitivity Rating (Per J-STD-020) | MSL1 |

## 4. Recommended Operating Conditions

Table 3. Recommended Operating Conditions


1. For normal operation, connect $\mathrm{VSS}_{E X T}=0 \mathrm{~V}$ (pin 20) to GND to enable the internal negative voltage generator. By applying $\mathrm{VSS}_{\mathrm{EXT}}$ to pin 20, the negative voltage generator is disabled thereby completely eliminating any generator spurious responses.
2. Levels based on $\mathrm{T}_{\mathrm{C}} \leq 85^{\circ} \mathrm{C}$. See Figure 1 power derating curve for higher case temperatures.
3. In any of the insertion loss modes or switching into any insertion loss mode, the 3 remaining terminated port paths can be each exposed to the maximum stated power level during continuous or hot switching operation.


Figure 1. Maximum RF Input Power vs. RF Frequency

## 5. Electrical Specifications

Typical Application Circuit, Normal mode ( $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$, $\mathrm{VSS} \mathrm{EXT}=0 \mathrm{~V}$ ) or Bypass mode ( $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$, $V_{S S}$ ext $=-3.3 \mathrm{~V}$ ), $\mathrm{Tc}_{\mathrm{c}}=+25^{\circ} \mathrm{C}, \mathrm{F}_{\mathrm{RF}}=2000 \mathrm{MHz}$, Input power $=0 \mathrm{dBm}, \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega$, RFX = one of the four input ports, PCB board trace and connector losses are de-embedded unless otherwise noted.

Table 4. Electrical Specifications

| Parameter | Symbol | Conditions |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Logic Input High Threshold | $\mathrm{V}_{\text {IH }}$ |  |  | 1.1 |  | Minimum $\left(3.6, V_{D D}\right)$ | V |
| Logic Input Low Threshold | $\mathrm{V}_{\text {IL }}$ |  |  | -0.3 |  | 0.6 | V |
| Logic Current | $\mathrm{I}_{\mathrm{IH},} \mathrm{I}_{\mathrm{IL}}$ | For each control pin |  | -2 |  | +2 | $\mu \mathrm{A}$ |
| DC Current ( $\mathrm{V}_{\mathrm{DD}}$ ) | IDD | Normal Mode | 3.3 V or 1.8V Logic |  | 290 | 360 | $\mu \mathrm{A}$ |
|  |  | Bypass Mode | 3.3 V or 1.8V Logic |  | 270 | 340 |  |
| DC Current ( $\mathrm{VSS}_{\text {EXT }}$ ) | Ivss | VSSExt $=-3.3 \mathrm{~V}$ |  |  | -44 | -60 | $\mu \mathrm{A}$ |
| Insertion Loss <br> RFX to RFC | IL | 900 MHz |  |  | 0.90 | $1.4{ }^{1}$ | dB |
|  |  | 2100 MHz |  |  | 1.1 | 1.5 |  |
|  |  | 2700 MHz |  |  | 1.15 | 1.6 |  |
|  |  | $2700 \mathrm{MHz}-4000 \mathrm{MHz}$ |  |  | 1.2 | $1.65{ }^{2}$ |  |
|  |  | $4000 \mathrm{MHz}-8000 \mathrm{MHz}$ |  |  | 1.8 |  |  |
| Minimum Isolation RFX to RFC | ISOC | 400 MH | - 900 MHz | 56 | 62.2 |  | dB |
|  |  | 900 MH | 2100 MHz | 48.5 | 55.4 |  |  |
|  |  | $2100 \mathrm{MHz}-2700 \mathrm{MHz}$ |  | 48 | 53.5 |  |  |
|  |  | $2700 \mathrm{MHz}-4000 \mathrm{MHz}$ |  | 46 | 50 |  |  |
|  |  | $4000 \mathrm{MHz}-5000 \mathrm{MHz}$ |  | 46 | 50 |  |  |
|  |  | $5000 \mathrm{MHz}-8000 \mathrm{MHz}$ |  | 29.5 | 35.7 |  |  |
| Minimum Isolation RFX to RFX | ISOX | 400 MH | - 900 MHz | 55 | 60.3 |  | dB |
|  |  | 900 MH | 2100 MHz | 49.5 | 53.6 |  |  |
|  |  | $2100 \mathrm{MHz}-2700 \mathrm{MHz}$ |  | 47 | 52 |  |  |
|  |  | $2700 \mathrm{MHz}-4000 \mathrm{MHz}$ |  | 43 | 47.6 |  |  |
|  |  | $4000 \mathrm{MHz}-5000 \mathrm{MHz}$ |  | 40 | 45 |  |  |
|  |  | $5000 \mathrm{MHz}-8000 \mathrm{MHz}$ |  | 29 | 36 |  |  |
| Total Coupling RFC to RFX | CPL ${ }_{\text {RF }}$ | Difference between and 3 terminated RFC port. 50 MHz | tive RFX input signal input signals at the 000 MHz . | 42 |  |  | dB |
| Maximum RFX Port VSWR During Switching | $\mathrm{VSWR}_{\text {T }}$ | From RFX | ve to RFX Term |  | 1.7:1 |  | - |
|  |  | From RFX Term to RFX Active |  |  | 2:1 |  |  |
| Minimum Return Loss (RFC Port ) | RFC RLL | $400 \mathrm{MHz}-4000 \mathrm{MHz}$ |  |  | 15 |  | dB |


| Parameter | Symbol | Conditions |  |  | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Minimum Return Loss (RFX Port ) | RFX ${ }_{\text {RL }}$ | $400 \mathrm{MHz}-4000 \mathrm{MHz}$ |  | Active |  | 13 |  | dB |
|  |  |  |  | Terminated |  | 17 |  |  |
| Input 0.1dB Compression ${ }^{3}$ | $I C P_{0.1 d B}$ |  |  |  |  | 35 |  | dBm |
| Input IP2 | IIP2 | $\mathrm{F}_{\mathrm{RF} 1}=2000 \mathrm{MHz}, \mathrm{F}_{\mathrm{RF} 2}=2010 \mathrm{MHz}$ RF Input $=$ RFX, $\mathrm{P}_{\mathrm{IN}}=+20 \mathrm{dBm} /$ tone $\mathrm{F}_{\mathrm{RF} 1}+\mathrm{F}_{\mathrm{RF} 2}$ Term |  |  |  | 114 |  | dBm |
| Input IP3 | IIP3 | $\begin{gathered} \Delta \mathrm{F}=1 \mathrm{MHz} \\ \mathrm{RF} \text { Input }=\mathrm{RFX} \\ \mathrm{PIN}=+20 \mathrm{dBm} / \text { tone } \end{gathered}$ |  | $\mathrm{F}_{\mathrm{RF}}=2000 \mathrm{MHz}$ |  | 59.5 |  | dBm |
|  |  |  |  | $\mathrm{F}_{\mathrm{RF}}=4000 \mathrm{MHz}$ |  | 60 |  |  |
| Switching Time ${ }^{4}$ | $\mathrm{T}_{\text {sw }}$ | Bypass Mode | 50\% CTR | L to 90\% RF |  | 256 | 345 | ns |
|  |  |  | 50\% CTR | L to 10\% RF |  | 256 | 345 |  |
|  |  |  | $\begin{array}{r} 50 \% \text { CTR } \\ \text { within +/- } 0 . \end{array}$ | to RF settled dB of I.L. value. |  | 285 |  |  |
| Maximum Switching Rate ${ }^{5}$ | SW ${ }_{\text {Rate }}$ | Pin $20=$ GND |  |  |  | 25 |  | kHz |
|  |  | Pin $20=$ VSS ${ }_{\text {ext }}$ applied |  |  |  | 290 |  |  |
| Maximum spurious level on any RF port ${ }^{6}$ | Spur $_{\text {max }}$ | RF ports terminated into $50 \Omega$ RFX connected to RFC |  |  |  | -120 |  | dBm |

1. Items in min/max columns in bold italics are guaranteed by Test.
2. Items in min/max columns that are not bold/italics are guaranteed by Design Characterization.
3. The input 0.1 dB compression point is a linearity figure of merit. Refer to Absolute Maximum Ratings section for the maximum RF input power and Figure 1 for maximum operating RF input power.
4. $F_{R F}=1 G H z$.
5. Minimum time required between switching of states $=1 /$ (Maximum Switching Rate).
6. Spurious due to on-chip negative voltage generator. Typical generator fundamental frequency is 2.2 MHz .

Table 5. 3-Pin Switch Control Truth Table

| Mode | V3 | V2 | V1 |
| :---: | :---: | :---: | :---: |
| RF4 on* | 0 | 0 | 0 |
| RF1 on | 0 | 0 | 1 |
| RF2 on | 0 | 1 | 0 |
| RF3 on | 0 | 1 | 1 |
| RF4 on | 1 | 0 | 0 |
| All off | 1 | 0 | 1 |
| All off | 1 | 1 | 0 |
| All off | 1 |  |  |

1.     * Redundant state with state " 100 "

Table 2: 2-Pin Switch Control Truth Table ${ }^{1,2}$

| Mode | V2 | V1 |
| :---: | :---: | :---: |
| RF4 on | 0 | 0 |
| RF1 on | 0 | 1 |
| RF2 on | 1 | 0 |
| RF3 on | 1 | 1 |

1. Note 1 - Pin 19 (V3) must be grounded for 2-pin control.
2. Note $2-2$-pin control can be used if All Off mode is not required.

## 6. Typical Operating Conditions (TOC)

Unless otherwise noted for the TOC graphs on the following pages, the following conditions apply.

- $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}$.
- $\mathrm{T}_{\text {CASE }}=+25^{\circ} \mathrm{C}\left(\mathrm{T}_{\text {CASE }}=\right.$ Temperature of exposed paddle $)$.
- $F_{R F}=2000 \mathrm{MHz}$.
- RFX is the driven RF port and RFC is the output port.
- Pin $=10 \mathrm{dBm}$ for all small signal tests.
- Pin $=+15 \mathrm{dBm} /$ tone applied to selected RFX port for two tone linearity tests.
- Two tone frequency spacing $=5 \mathrm{MHz}$.
- $Z_{\mathrm{s}}=\mathrm{Z}_{\mathrm{L}}=50$ ohms.
- All unused RF ports terminated into 50 ohms.
- For Insertion Loss and Isolation plots, RF trace and connector losses are de-embedded (see EVKIT Board and Connector loss plot).
- Plots for Isolation and Insertion Loss over temperature and voltage are for a typical path. For performance of a specific path, refer to the online S-Parameter file.


I nsertion Loss vs. Voltage


RFX $\rightarrow$ RFC I solation vs. Voltage


Insertion Loss vs. Temperature


RFX $\rightarrow$ RFC I solation vs. Temperature


RFX $\rightarrow$ RFX I solation vs. Temperature



RFX Selected Return Loss vs. Temperature


RFC Return Loss vs. Selected RFX Port


RFX Return Loss vs. Selected RFX Port


RFX Selected Return Loss vs. Voltage


RFC Return Loss with RFX Selected vs. Temperature



RFX Terminated Return Loss vs. Temperature


## Return Loss (During Switching) vs. Time



RFX Terminated Return Loss vs. RFX Port


RFX Terminated Return Loss vs. Voltage


VSWR (During Switching) vs. Time


RFX Switching Time [RFX Terminated to RFX Active]


RFX I I P3 vs. Selected RFX Port


RFX Switching Time [RFX Active to RFX Terminated]


RFX I I P3 vs. Temperature and Voltage


EVKIT Trace and Connector Loss vs. Temperature


## 7. Applications Information

### 7.1 Default Start-up

Control pins include no internal pull-down resistors to logic LOW or pull-up resistors to logic HIGH.

### 7.2 Logic Control

Three control pins V1, V2, and V3 are used to set the state of the SP4T switch (see Table 1 or Table 2).

### 7.3 External Vss

The F2914 is designed with an on-chip negative voltage generator. This on-chip generator is enabled by connecting pin 20 of the device to ground. To disable the on-chip generator apply a negative voltage to pin 20 (VSSEXT) of the device within the range stated in the Recommended Operating Conditions Table.

### 7.4 Power Supplies

A common VDD power supply should be used for all pins requiring DC power. All supply pins should be bypassed with external capacitors to minimize noise and fast transients. Supply noise can degrade noise figure and fast transients can trigger ESD clamps and cause them to fail. Supply voltage change or transients should have a slew rate smaller than $1 \mathrm{~V} / 20 \mathrm{uS}$. In addition, all control pins should remain at $0 \mathrm{~V}(+/-0.3 \mathrm{~V})$ while the supply voltage ramps or while it returns to zero.

### 7.5 Control Pin Interface

If control signal integrity is a concern and clean signals cannot be guaranteed due to overshoot, undershoot, ringing, etc., the following circuit at the input of each control pin is recommended. This applies to control pins 17, 18, and 19 as shown below.


## 8. EvKit Picture

Top View


Bottom View


## 9. EVkit / Applications Circuit



## 10. EVKit BOM

| Part Reference | QTY | DESCRIPTION | Mfr. Part \# | Mfr. |
| :---: | :---: | :--- | :--- | :---: |
| C1, C3, C5, C7, <br> C8, C9 | 6 | $100 \mathrm{pF} \pm 5 \%, 50 \mathrm{~V}, \mathrm{COG}$ Ceramic Capacitor (0402) | GRM1555C1H101J | Murata |
| C2 | 0 | Not Installed (0603) |  |  |
| C4 | 0 | Not Installed (0603) |  |  |
| C6 | 1 | $1000 \mathrm{pF} \pm 5 \%, 50 \mathrm{~V}$, C0G Ceramic Capacitor (0603) | GRM1885C1H102J | Murata |
| R1, R2, R3 | 3 | $0 \Omega \pm 1 \%, 1 / 10 \mathrm{~W}$, Resistor (0402) | ERJ-2GE0R00X | Panasonic |
| R4, R5, R6 | 3 | $100 \mathrm{k} \Omega \pm 1 \%, 1 / 10 \mathrm{~W}$, Resistor (0402) | ERJ-2RKF1502X | Panasonic |
| R7 | 1 | $15 \mathrm{k} \Omega \pm 1 \%, 1 / 10 \mathrm{~W}$, Resistor (0402) | ERJ-2RKF2202X | Panasonic |
| R8 | 1 | $22 \mathrm{k} \Omega \pm 1 \%, 1 / 10 \mathrm{~W}$, Resistor (0402) | 142-0701-851 | Emerson Johnson |
| J1, J3-J8 | 7 | Edge Launch SMA (0.375 inch pitch ground tabs) | 67997-120HLF | FCI |
| J9 | 1 | CONN HEADER VERT DBL 10 $\times 2$ POS GOLD | F2914NBGK | IDT |
| U1 | 1 | SP4T Switch 4 mm x 4 mm QFN24-EP | F29XX EVKIT Rev 02.0 | IDT |

## 11. EVkit Operation

### 11.1 External Supply Setup

Set up a VDD power supply in the voltage range of 2.7 V to 5.5 V and disable the power supply output. If using the on-chip negative voltage generator install a 2-pin shunt to short out pins 3 and 4 of J 9 .

If an external negative voltage supply is to be used set the supply voltage within the range of -3.6 V to
-3.2 V and disable the negative voltage power supply output. Also, be sure there are no jumper connections on pins 3 and 4 of J 9 .

### 11.2 Logic Control Setup

Using the EVKIT to manually set the control logic:
On connector 39 connect a 2-pin shunt from pin 7 (VDD) to pin 8 (VDD_CTRL). This connection provides the VDD voltage supply to the Eval Board logic control pull up network.

On connector 39 connect a 2-pin shunt from pin 9 (LVSEL2) to pin 10 (LVSEL). This connection enables R7 (15 $k \Omega$ ) and R8 ( $22 \mathrm{k} \Omega$ ) to form a voltage divider to set the proper logic control levels to support the full voltage range of VDD. Note that when using the on-board R7 / R8 voltage divider the current draw from the VDD supply will be higher by approximately VDD / $37 \mathrm{k} \Omega$.

Connector J9 has 3 logic input pins: V1 (pin 20), V2 (pin 18), and V3 (pin 16). See Table 1 or Table 2 for Logic Truth Table. With the pullup network enabled (as noted above), these pins open will provide a logic high through pull up resistors R4, R5, and R6. To set a logic low to V1, V2, and V3 connect 2-pin shunts from pin 16 to pin 15, pin 18 to pin 17 and pin 20 to pin 19 respectively.

### 11.3 Using External Control Logic

Pins 6, 7, 8, 9, and 10 of J 9 should have no connection. External logic controls would be applied to J9 pins 16 (V3), 18 (V2) and 20 (V1). See Table 1 or Table 2 for Logic Truth Table.

### 11.4 Turn on Procedure

1. Setup the supplies and Eval Board as noted in the External Supply Setup and Logic Control Setup sections above.
2. Connect the preset disabled VDD power supply to pin 2 (VDD) and pin 1 (GND) of $\mathrm{J9}$.
3. If the external negative voltage source is to be used, connect the disabled supply to pin 4 (VSSEXT) and pin 3 (GND) of J9. If using on-chip negative supply be sure the 2 -pin shunt is installed connecting pin 3 to pin 4.
4. Enable the VDD supply then enable the VSSEXT supply (if used).
5. Set the desired logic setting using V1, V2, and V3 to achieve the desired Table 1 or Table 2 setting. Note that external control logic should not be applied without VDD being applied first.

### 11.5 Turn off Procedure

1. If using external control logic for $\mathrm{V} 1, \mathrm{~V} 2, \mathrm{~V} 3$ then set to a logic low.
2. Disable any external VSSEXT supply.
3. Disable the VDD supply.

## 12. Package Outline Drawings

The package outline drawings are appended at the end of this document. The package information is the most current data available.

## 13. Marking Diagram



## 14. Ordering Information

| Part Number | Description | Temperature Range ( ${ }^{\circ} \mathrm{C}$ ) | Carrier Type |
| :---: | :---: | :---: | :---: |
| F2914NBGK8 | T.0 | -40 to +85 |  |

## 15. Revision History

| Revision | Date |  |
| :---: | :---: | :--- |
| 1.0 | Dec.1.20 | • Updated RFX to RFC and RFX to RFX isolation specifications. <br> • Added Total Coupling RFC to RFX specification. |
| N/A | Jun.19.20 | Completed minor changes throughout. |
| N/A | Mar.1.16 | Initial release. |



COMMON

|  |  |
| :---: | :---: |
|  | MIN |
| D2 | 2.60 |
| E2 | 2.60 |
| L | 0.30 |
| D |  |
| E |  |
| e |  |
| A | 0.70 |
| A1 | 0.00 |
| b | . 20 |
| ada |  |
| bbb |  |
| ccc |  |
| ddd |  |
| eee |  |
| fff |  |

## NOTES:

```
1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSIONS ARE IN MLLIMETERS
```



## RECOMMENDED LAND PATTERN DIMENSION

NOTES:

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOWN FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

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